Features

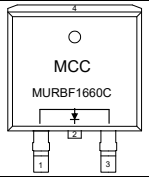
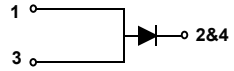
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant(Note 2) ("P" Suffix Designates Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Low Switching Losses and High Efficiency
- Low Reverse Leakage
- Ultrafast Recovery Time
- Planar Structure Die and Soft Recovery Characteristics

16 Amp FRED Rectifiers 600 Volts

Maximum Ratings @ 25°C (Unless Otherwise Specified)

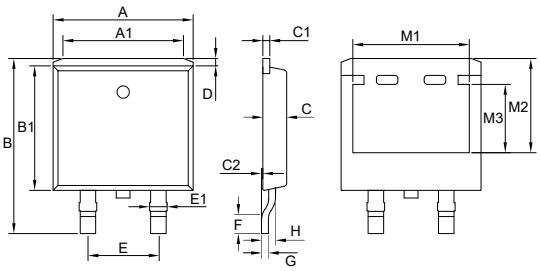
Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	600	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	V_{RMS}	420	V
Average Rectified Forward Current	$I_{F(AV)}$	16	A
Non−Repetitive Peak Surge Current @8.3ms Half Sine Wave	I_{FSM}	200	A
Current Squared Time @ 1ms≤t≤8.3ms	I^2t	166	A^2s

Internal Structure

Pin	Description	Simplified Outline	Graphic Symbol
2&4	Cathode		
1&3	Anode		

Note :
1.Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High temperature solder exemption applied, see EU directive annex 7a.

TO-263AC



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.388	0.407	9.85	10.35	
A1	0.323	0.339	8.20	8.60	
B	0.467	0.490	11.85	12.45	
B1	0.346	0.361	8.78	9.18	
C	0.062	0.074	1.57	1.87	
C1	0.014	0.026	0.35	0.65	
C2	0.000	0.008	0.00	0.20	
D	0.015	0.027	0.39	0.69	
E	0.196	0.204	4.98	5.18	
E1	0.044	0.056	1.12	1.42	
F	0.051	0.059	1.30	1.50	
G	0.014	0.026	0.35	0.65	
H	0.033	0.049	0.85	1.25	
M1	0.327	0.343	8.30	8.70	
M2	0.264	0.280	6.70	7.10	
M3	0.185	0.201	4.70	5.10	

Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_J	Operating Junction Temperature Range		-55		175	°C
T_{stg}	Storage Temperature Range		-55		175	°C
$Rth_{(J-C)}$	Thermal Resistance from Junction to Case			2		°C/W

Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage	V_F	I_F=16A;T_J=25°C		1.10	1.30	V
		I_F=16A;T_J=125°C		0.92	1.20	
Reverse Current	I_R	V_R=600V;T_J=25°C			10	uA
		V_R=600V;T_J=125°C			100	
Junction Capacitance	C_J	V_R=600V;f=1MHz;T_J=25°C		20		pF

Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Typ	Max	Unit
Reverse Recovery Time	t_{rr}	I_F=0.5A; I_R=1.0A;I_{RR}=0.25A;T_J=25°C			50	55	ns
		I_F=1A,di_F/dt=-50A/us,V_R=30V;T_J=25°C			57		
		I_F=16A di_F/dt=-200A/µs V_{RM}=400V	T_J=25°C		94		
			T_J=125°C		142		
Peak Recovery Current	I_{RRM}		T_J=25°C		9.36		A
			T_J=125°C		16.34		
Reverse Recovery Charge	Q_{rr}		T_J=25°C		442		nC
			T_J=125°C		1163		

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

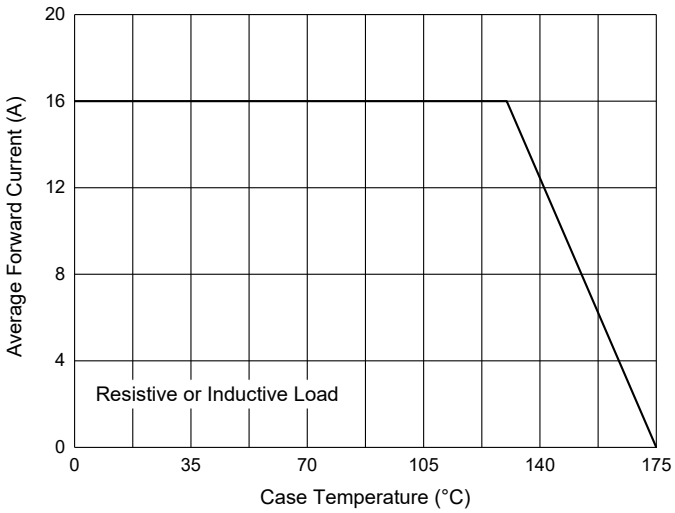


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

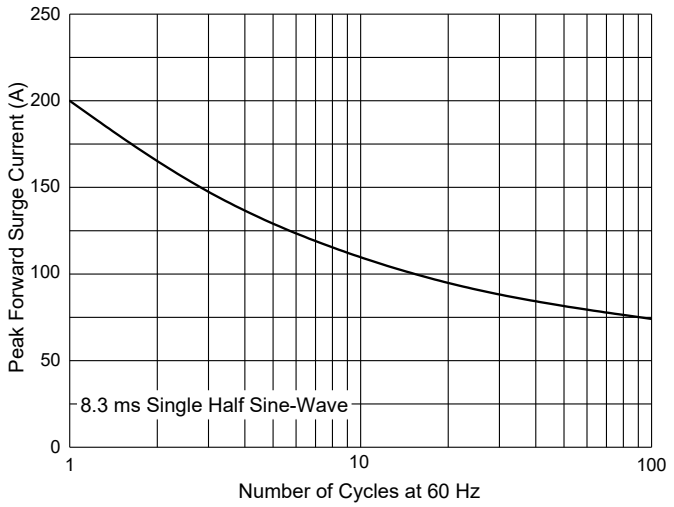


Fig. 3 - Typical Forward Characteristics

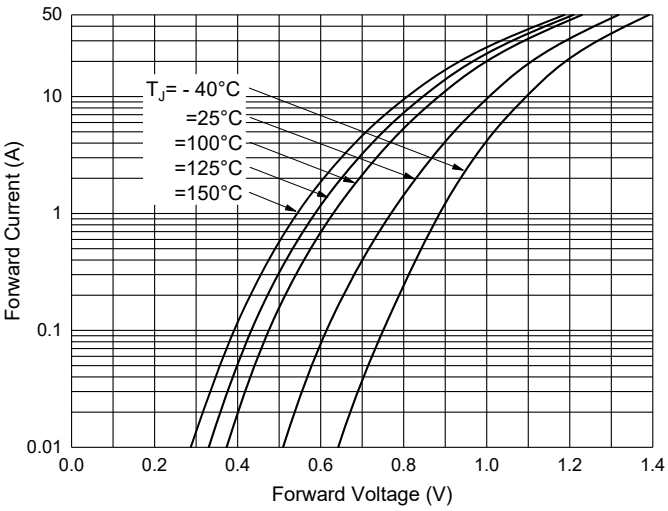


Fig. 4 - Typical Reverse Leakage Characteristics

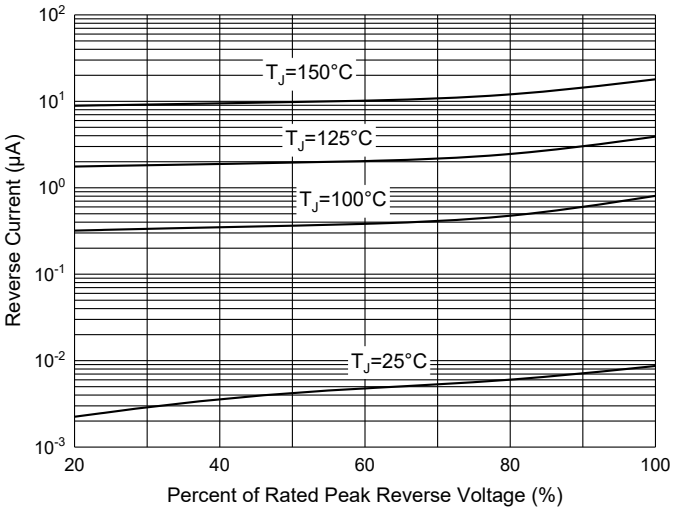


Fig. 5 - Typical Capacitance Characteristics

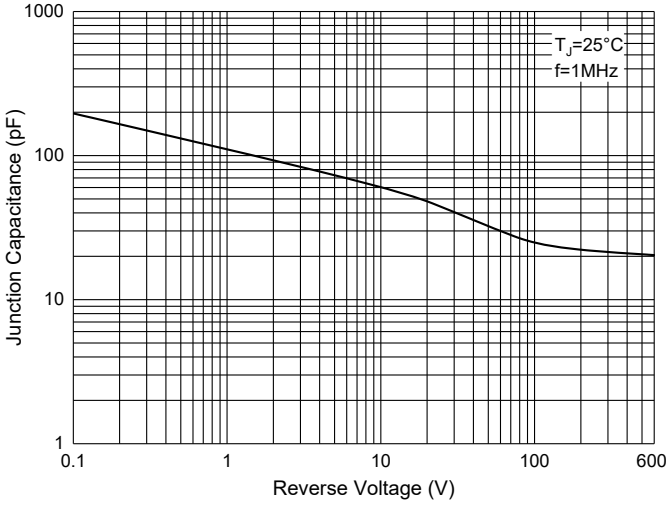
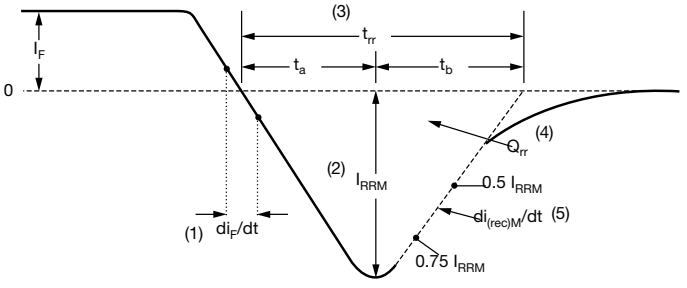


Fig. 6 - Reverse Recovery Waveform and Definitions



(1) di_F/dt - rate of change of current through zero crossing

(2) I_{RRM} - peak reverse recovery current

(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.

(4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 1500pcs/Reel